



DOCKET NO.: 238663US-3993-3993-25 DIV

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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

Jack D. PIPPIN

: GROUP ART UNIT: 2824

SERIAL NO.: 09/707,448

: EXAMINER:

FILED: November 7, 2000

:

FOR: TEMPERATURE AVERAGING THERMAL SENSOR APPARATUS AND METHOD

REVOCATION AND NEW APPOINTMENT OF POWER OF ATTORNEY

Assistant Commissioner for Patents
Washington, D.C. 20231

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Sir:

The undersigned representative of INTEL CORPORATION, owner by virtue of assignment of the above-identified application, hereby revokes any and all previous Powers of Attorney and appoints



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as Assignee's attorney with full power of substitution and revocation, to prosecute said patent application, receive any Letters Patent and to take any and all other actions with regard to this patent application and any Letters Patent issuing thereon, and request that all correspondence be sent to the firm of OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C. whose Post Office Address is: 1940 Duke Street, Alexandria, Virginia 22314.



CERTIFICATION UNDER 37 C.F.R. 3.73(b)

I, the undersigned, certify that I am an individual empowered to act on behalf of
INTEL CORPORATION, the assignee of the entire right, title and interest of the above-identified
application by virtue of an assignment from the inventor(s), said Assignment having been recorded
in the U.S. Patent and Trademark Office at reel no. 011264, frame 0928.

INTEL CORPORATION

Date: June 10, 2003

By: 

David M. Simon
Chief Patent Counsel

(OSMMN 2000)



OSMM&N File No. 238663US25DIV

Serial No. 09/707,448

In the matter of the Application of: Jack D PIPPIN

For: TEMPERATURE AVERAGING THERMAL SENSOR APPARATUS AND METHOD

Dept.: INT

By: CLG/WTB/wmp

Due Date: NONE

The following has been received in the U.S. Patent Office on the date stamped hereon:

- ☐ Dep. Acct. Order Form
- ☐ Cover Letter
- ☐ Status Inquiry
- ☐ Revocation and New Appointment of Power of Attorney

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